

700 MHz, -3 dB Bandwidth; Dual SPDT Analog Switch

DESCRIPTION

DG2723 is a low R_{ON} , high bandwidth analog switch configured in dual SPDT. It achieves 5.5 Ω switch on resistance, greater than 700 MHz -3 dB bandwidth with 5 pF load, and a channel to channel crosstalk at -36 dB and isolation at -29 dB. Fabricated with high density sub micro CMOS process, the DG2723 provides low parasitic capacitance, handles bidirectional signal flow with minimized phase distortion. Guaranteed 1.3 V logic high threshold makes it possible to interface directly with low voltage MCUs. The DG2723 is designed for a wide range of operating voltages from 2.7 V to 5.5 V that can be driven directly from one cell Li-ion battery. On-chip protection circuit protects against fault events when signals at "com" pins goes beyond V_{+} .

Latch up current is 500 mA, as per JEDEC78, and its ESD tolerance exceeds 5 kV. Packaged in ultra small miniQFN-10 (1.4 mm x 1.8 mm x 0.55 mm), it is ideal for portable high speed mix signal switching application.

As a committed partner to the community and the environment, Vishay Siliconix manufactures this product with lead (Pb)-free device termination. The miniQFN-10 package has a nickel-palladium-gold device termination and is represented by the lead (Pb)-free "-E4" suffix to the ordering part number. The nickel-palladium-gold device terminations meet all JEDEC® standards for reflow and MSL rating. As a further sign of Vishay Siliconix's commitment, the DG2723 is fully RoHS compliant.

FEATURES

- Wide operation voltage range
- Low on-resistance, 5.5 Ω (typical at 3 V)
- Low capacitance, 5.6 pF (typical)
- -3 dB high bandwidth with 5pF load: 700 MHz (typical)
- Low bit to bit skew: 40 pS (typical)
- Low power consumption
- Low logic threshold: V
- Power down protection: D+/D- pins can tolerate up to 5.5 V when $V_{+} = 0$ V
- Logic (S+ and S-) above V_{+} tolerance
- 5 kV ESD protection (HBM)
- Latch-up current 500 mA per JEDEC78
- Lead (Pb)-free low profile miniQFN-10 (1.4 mm x 1.8 mm x 0.55 mm)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

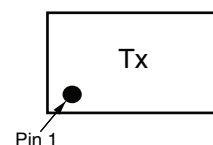
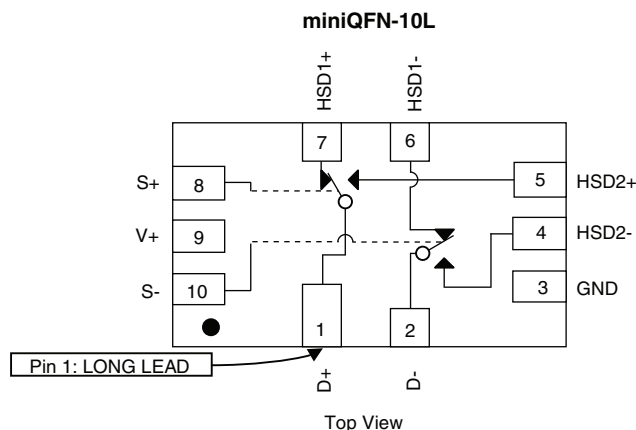


RoHS
COMPLIANT

APPLICATIONS

- Cellular phones
- Portable media players
- PDA
- Digital camera
- GPS
- Notebook computer
- TV, monitor, and set top box

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION



Device marking: Tx for DG2723
x = Date/Lot traceability code

**ORDERING INFORMATION**

TEMP. RANGE	PACKAGE	PART NUMBER
-40 °C to 85 °C	miniQFN-10	DG2723DN-T1-E4

TRUTH TABLE

S+ (PIN 8)	S- (PIN 10)	FUNCTION
X	0	D- = HSD1-
X	1	D- = HSD2-
0	X	D+ = HSD1+
1	X	D+ = HSD2+

PIN DESCRIPTIONS

PIN NAME	DESCRIPTION
S+	Select Input for D+
S-	Select Input for D-
HSD±, HSD2±, D±	Data Port

ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ °C}$, unless otherwise noted)

PARAMETER		LIMIT	UNIT
Reference to GND	V+	-0.3 to 6	V
	S+, S-, D±, HSD1±, HSD2± ^a	-0.3 to (V+ + 0.3)	
Current (Any Terminal except S+, S-, D±, HSD1±, HSD2±)		30	mA
Continuous Current (S+, S-, D±, HSD1±, HSD2±)		± 250	
Peak Current (Pulsed at 1 ms, 10 % Duty Cycle)		± 500	
Storage Temperature (D Suffix)		-65 to 150	°C
Power Dissipation (Packages) ^b	miniQFN-10 ^c	208	mW
ESD (Human Body Model)		5	kV
Latch-up (Current Injection)		500	mA

Notes

- a. Signals on S+, S-, D±, HSD1±, HSD2± exceeding V+ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
- b. All leads welded or soldered to PC board.
- c. Derate 2.6 mW/°C above 70 °C.

SPECIFICATIONS ($V_+ = 3\text{ V}$)

PARAMETER	SYMBOL	TEST CONDITIONS OTHERWISE UNLESS SPECIFIED	TEMP. ^a	LIMITS -40 °C to 85 °C			UNIT
				MIN. ^b	TYP. ^c	MAX. ^b	
Analog Switch							
Analog Signal Range ^d	V _{ANALOG}	R _{DS(on)}	Full	0	-	V+	V
On-Resistance	R _{DS(on)}	V+ = 3 V, I _{D±} = 8 mA, V _{HSD1/2±} = 0.4 V	Room	-	5.5	8	Ω
			Full	-	-	9	
On-Resistance Match ^d	ΔR _{ON}	V+ = 3 V, I _{D±} = 8 mA, V _{HSD1/2±} = 0.4 V	Room	-	0.8	-	
On-Resistance Resistance Flatness ^d	R _{ON} Flatness	V+ = 3 V, I _{D±} = 8 mA, V _{HSD1/2±} = 0 V, 1 V	Room	-	2	-	nA
Switch Off Leakage Current	I _(off)	V+ = 4.3 V, V _{HSD1/2±} = 0.3 V, 3 V, V _{D±} = 3 V, 0.3 V	Full	-100	-	100	
Channel On Leakage Current	I _(on)	V+ = 4.3 V, V _{HSD1/2±} = 0.3 V, 4 V, V _{D±} = 4 V, 0.3 V	Full	-200	-	200	
Digital Control							
Input Voltage High	V _{INH}	V+ = 3 V to 3.6 V	Full	1.3	-	-	V
		V+ = 4.3 V	Full	1.5	-	-	
Input Voltage Low	V _{INL}	V+ = 3 V to 4.3 V	Full	-	-	0.5	
Input Capacitance	C _{IN}		Full	-	6.5	-	pF
Input Current	I _{INL} or I _{INH}	V _{IN} = 0 or V+	Full	-1	-	1	μA

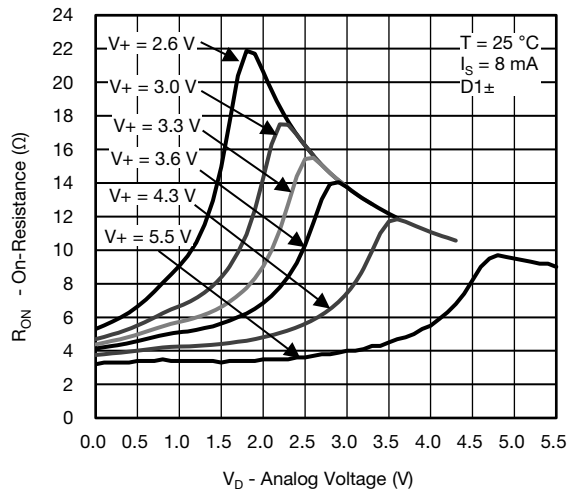
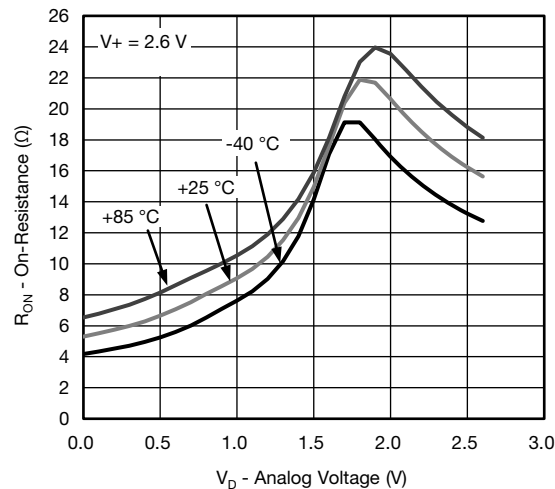
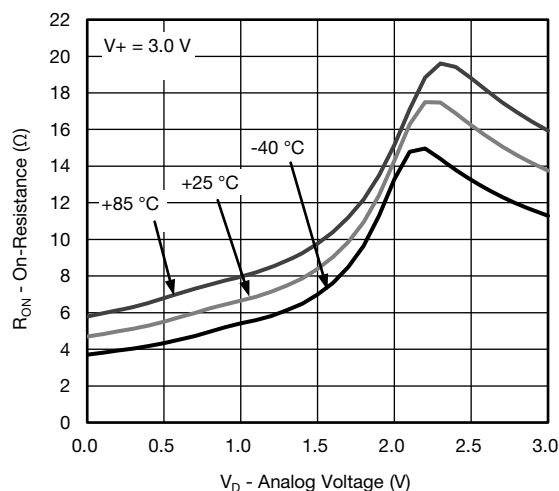
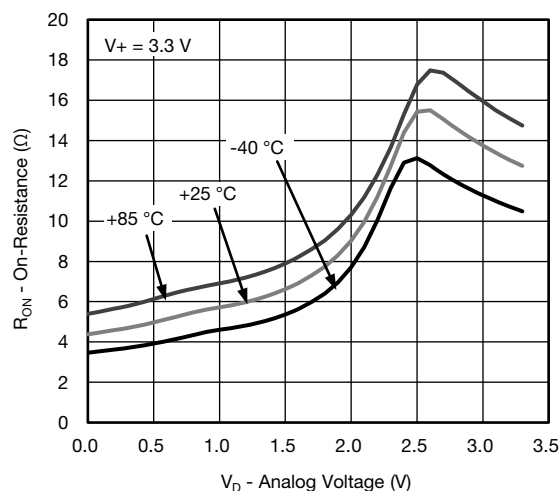
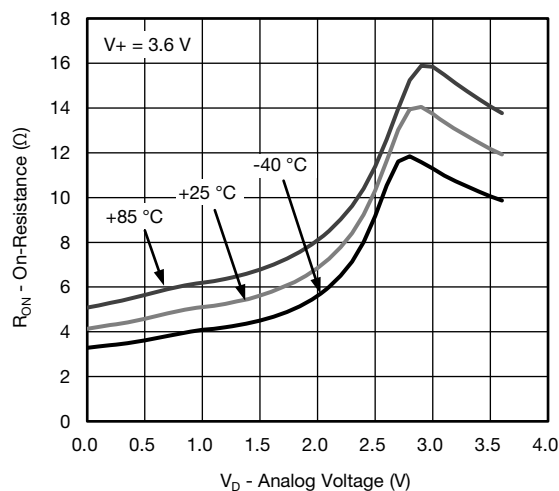
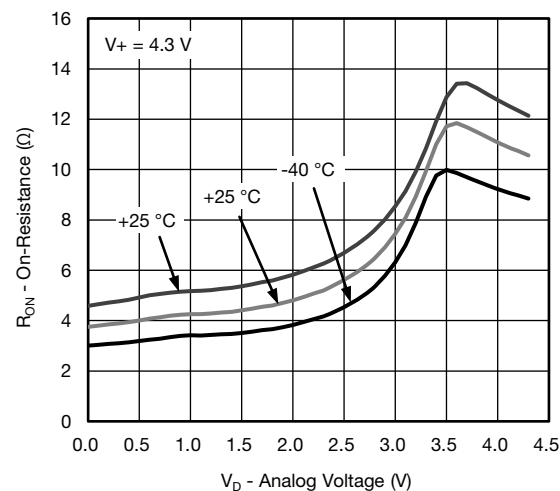


SPECIFICATIONS (V+ = 3 V)							
PARAMETER	SYMBOL	TEST CONDITIONS OTHERWISE UNLESS SPECIFIED	TEMP. ^a	LIMITS -40 °C to 85 °C			UNIT
				MIN. ^b	TYP. ^c	MAX. ^b	
Dynamic Characteristics							
Break-Before-Make Time ^{e, d}	t _{BBM}	V+ = 3 V, V _{D1/2±} = 1.5 V, R _L = 50 Ω, C _L = 35 pF	Room	-	5	-	ns
S-, S+ Turn-On Time ^{e, d}	t _{ON}		Full	-	-	-	
			Room	-	-	30	
S-, S+ Turn-Off Time ^{e, d}	t _{OFF}		Full	-	-	25	
			Room	-	-	-	
Charge Injection ^d	Q _{INJ}		C _L = 1 nF, R _{GEN} = 0 Ω, V _{GEN} = 0 V	Room	-	3	
Off-Isolation ^d	OIRR	V+ = 3 V to 3.6 V, R _L = 50 Ω, C _L = 5 pF, f = 240 MHz	-		-29	-	dB
Crosstalk ^d	X _{TALK}	-	-36		-		
Bandwidth ^d	BW	V+ = 3 V to 3.6 V, C _L = 5 pF, R _L = 50 Ω, -3 dB	-		700	-	MHz
Channel-Off Capacitance ^d	C _{D1± (off)}	V+ = 3.3 V, f = 1 MHz	-		2.5	-	pF
	C _{D2± (off)}		-		2.5	-	
Channel-On Capacitance ^d	C _{D± (off)}		-		2.5	-	
	C _{D± (on)}		-		6.5	-	
Channel-to-Channel Skew ^d	t _{SK(O)}	V+ = 3 V to 3.6 V, R _L = 50 Ω, C _L = 5 pF	-		50	-	ps
Skew Off Opposite Transitions of the Same Output ^d	t _{SK(p)}		-		20	-	
Total Jitter ^d	t _J		-		200	-	
Power Supply							
Power Supply Range	V+			2.6	-	5.5	V
Power Supply Current	I+	V _{IN} = 0 V, or V+	Full	-	-	2	μA

Notes

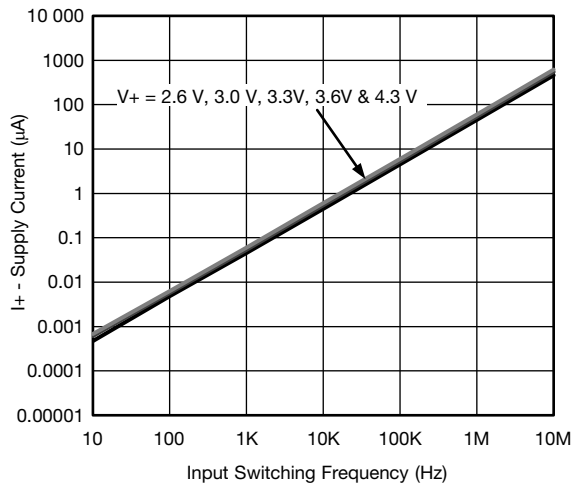
- a. Room = 25 °C, Full = as determined by the operating suffix.
b. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this datasheet.
c. Typical values are for design aid only, not guaranteed nor subject to production testing.
d. Guarantee by design, not subjected to production test.
e. V_{IN} = input voltage to perform proper function.
f. Crosstalk measured between channels.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

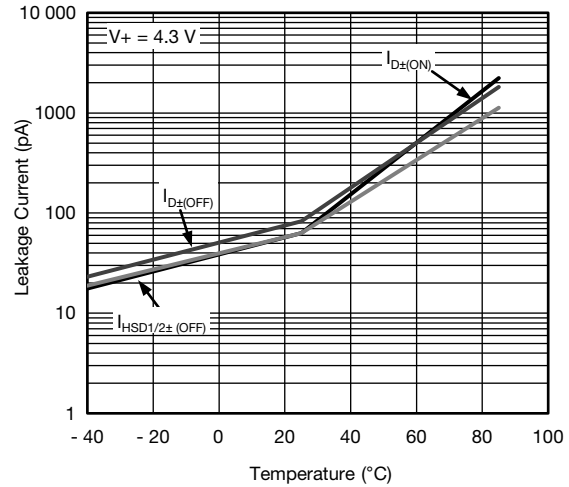
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

 R_{ON} vs. V_D and Single Supply Voltage

 R_{ON} vs. Analog Voltage and Temperature

 R_{ON} vs. Analog Voltage and Temperature

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 R_{ON} vs. Analog Voltage and Temperature



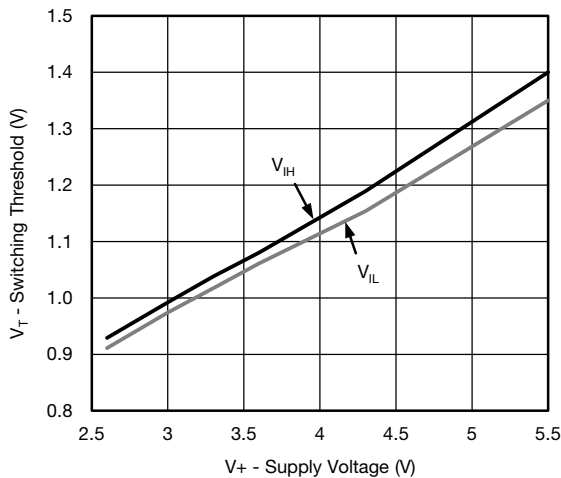
TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)



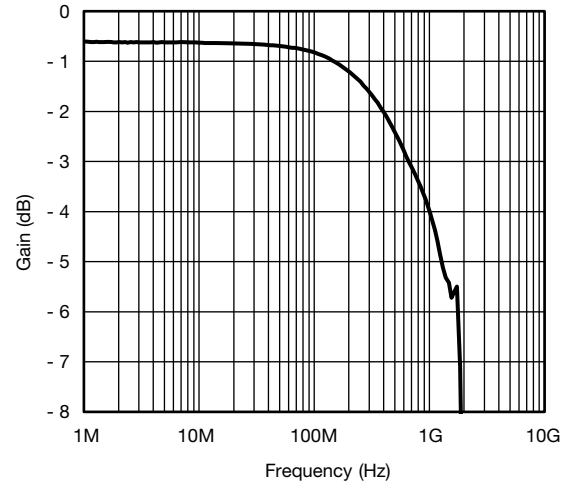
Supply Current vs. Input Switching Frequency



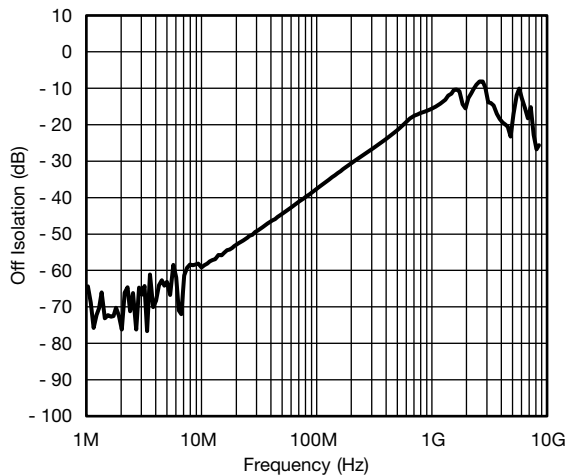
Leakage Current vs. Temperature



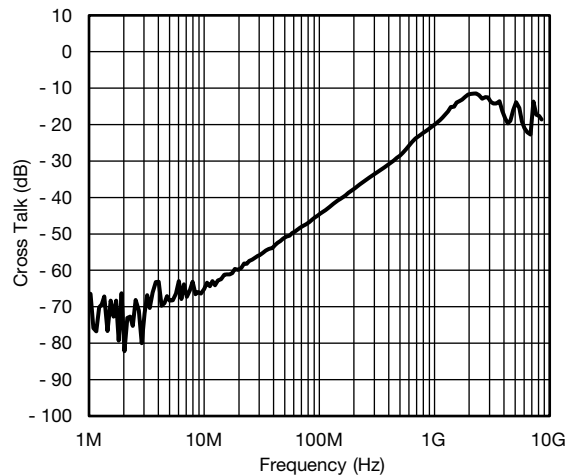
Switching Threshold vs. Supply Voltage



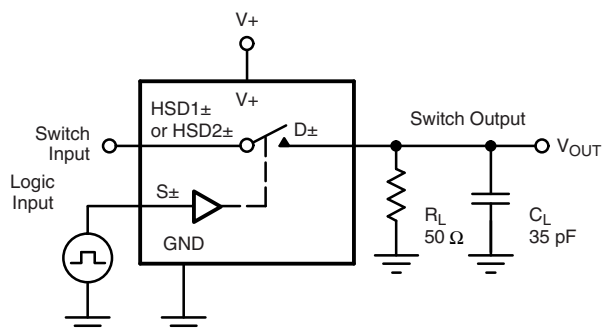
Gain vs. Frequency, $V_{+} = 3.3\text{ V}$



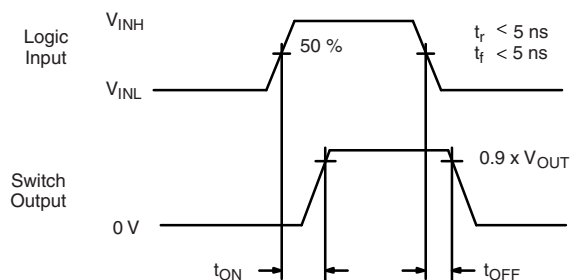
Off-Isolation, $V_{+} = 3.3\text{ V}$



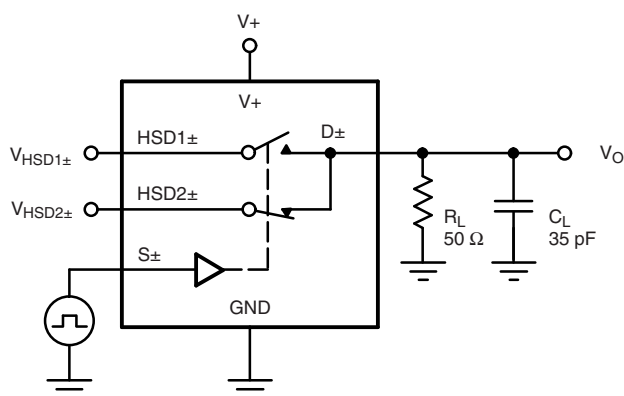
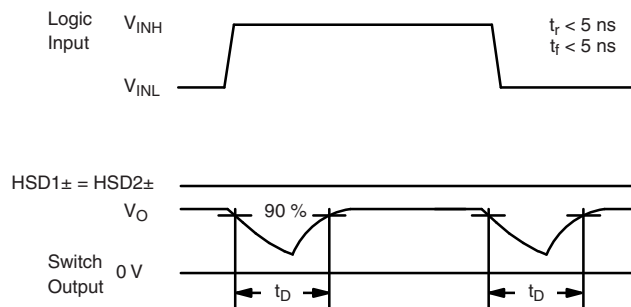
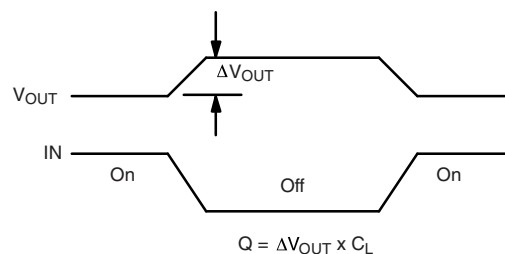
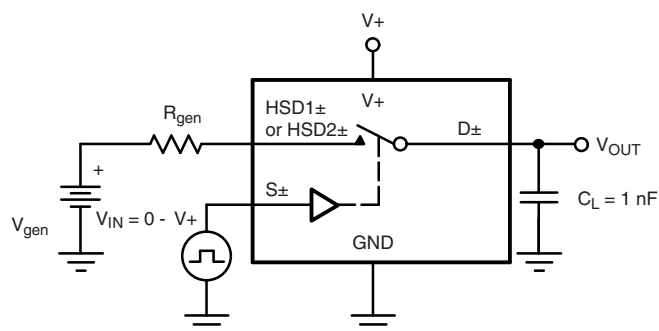
Crosstalk, $V_{+} = 3.3\text{ V}$

TEST CIRCUITS

 C_L (includes fixture and stray capacitance)

$$V_{OUT} = D_{\pm} \left(\frac{R_L}{R_L + R_{ON}} \right)$$

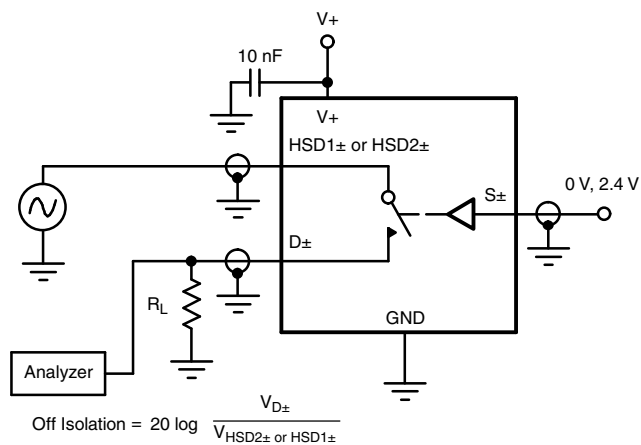
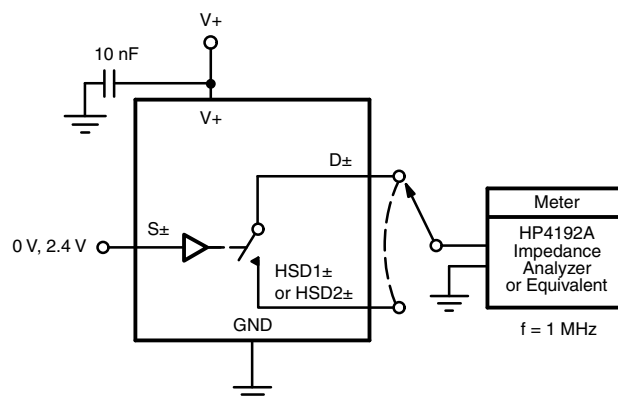


Logic "1" = Switch on
Logic input waveforms inverted for switches that have the opposite logic sense.

Fig. 1 - Switching Time

 C_L (includes fixture and stray capacitance)

Fig. 2 - Break-Before-Make Interval


IN depends on switch configuration: input polarity determined by sense of switch.

Fig. 3 - Charge Injection

TEST CIRCUITS

Fig. 4 - Off-Isolation

Fig. 5 - Channel Off/On Capacitance

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Technical drawing showing a 3x3 grid of rectangles. The drawing includes dimensions and tolerances for the grid layout and individual rectangles.

Grid Dimensions and Tolerances:

- Horizontal spacing between vertical grid lines: 1.700 (0.0669)
- Vertical spacing between horizontal grid lines: 2.100 (0.0827)
- Horizontal spacing between vertical grid lines (left side): 0.663 (0.0261)
- Horizontal spacing between vertical grid lines (right side): 0.200 (0.0079)
- Horizontal spacing between vertical grid lines (bottom side): 10 x 0.225 (0.0089)
- Horizontal spacing between vertical grid lines (top side): 9 x 0.563 (0.0221)

Rectangle Dimensions and Tolerances:

- Rectangle width: 0.400 (0.0157) Pitch
- Rectangle height: 0.200 (0.0079)
- Rectangle width (bottom side): 0.200 (0.0079)
- Rectangle height (right side): 0.200 (0.0079)

Other Dimensions:

- Distance from left edge to first vertical grid line: 0.200 (0.0079)
- Distance from bottom edge to first horizontal grid line: 0.400 (0.0157) Pitch

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